

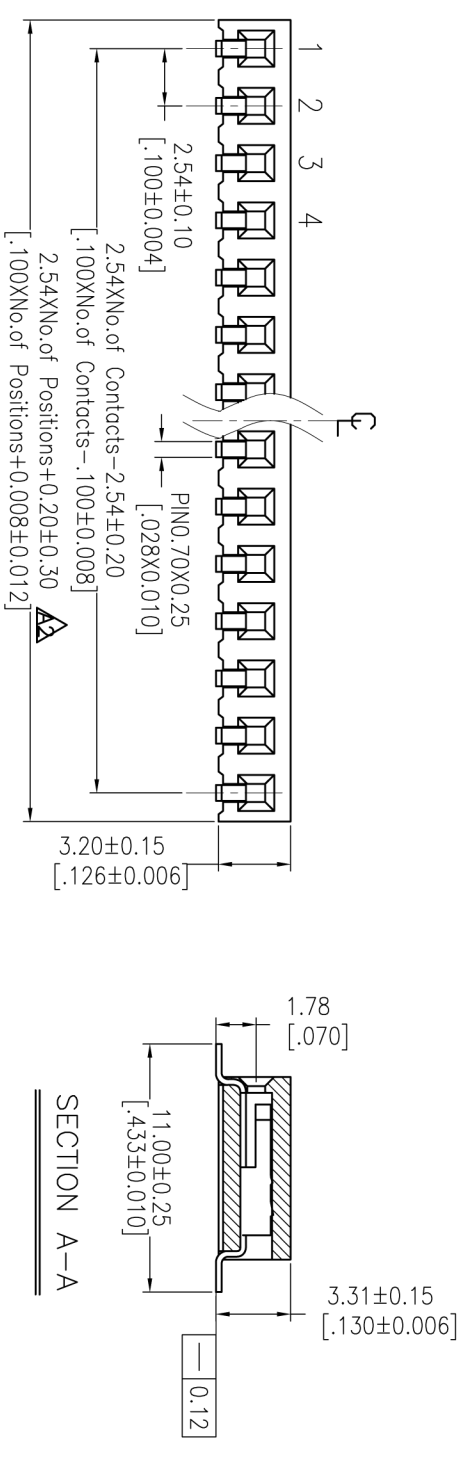
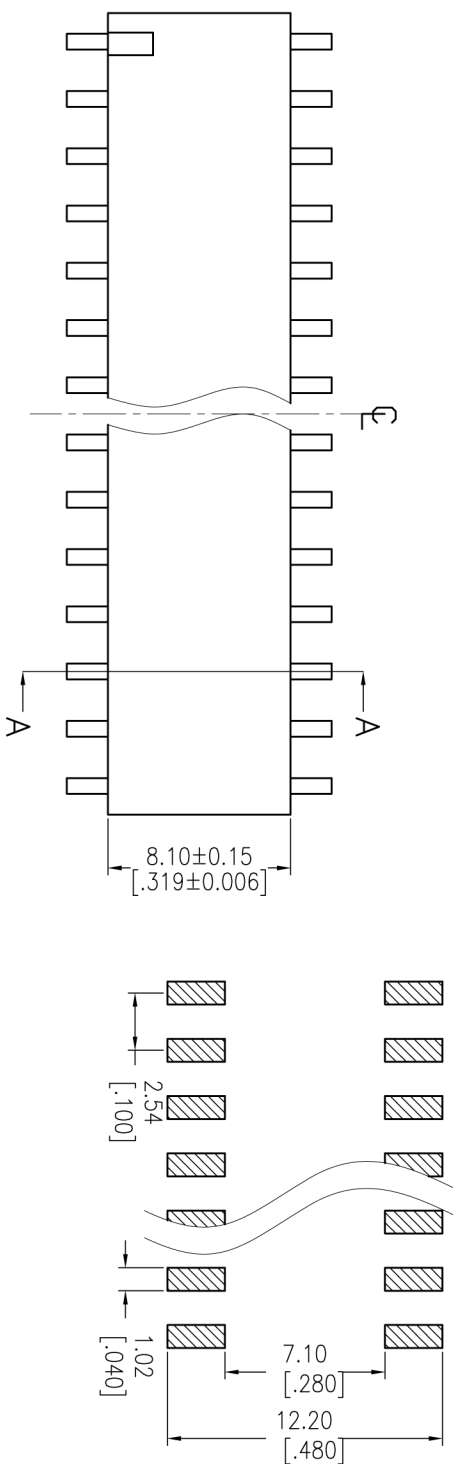
HSHF

NOTES:

Current Rating: 3.0AMP
 Contact Resistance: 20mΩ Max
 Withstand Voltage: 1000V AC/DC
 Insulation Resistance: 1000MΩ Min
 Operation Temperature: -40°C to +105°C

Contact Material: Phosphor Bronze
 Contact plating: Au Or Sn over Ni
 Insulator Material: PA9T+30%G.F UL94V-0

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

2134 - 1 XX M XX C U N X 1

No. of Pins per ROW: 92-40PIN
 Contact Plating:
 G0=Gold Flash
 G3=10μ"Gold
 G4=15μ"Gold
 G5=30μ"Gold
 S0=Gold Flash/Tin
 S3=10μ"Gold/Tin
 S4=15μ"Gold/Tin
 S5=30μ"Gold/Tin
 SN=Tin
 SM=Mate Tin

Packing:
 T=Tube
 R=Tray&Reel

Item	Pitch	Mating
Standard	2.54	1125B
Alternate		△

A2	2012/09/20	MODIFY ADD +0.20	OPERATION	DRAW	DATE	SCALE	FIT	PART NO.
A1	2012/08/24	Change the mating object	XX	JHuang	2012/09/20	mm		2134-1XXMXXCUNX1
A0	2012/08/02	NEW	XX	CHECK	DATE	A4		TITLE: FH2.54 SINGLE ROW 180° SMT SIDE ENTER H=3.2
REV	DATE	MODIFICATION DESCRIPTION	Angle	APPROVE	DATE	SHEET	1/1	Customer NO.
			± 3'			PROJ.		
			DIM	TOL				

hf 上海回峰电子科技有限公司
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